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Jong-Hyuk Kim Sung-Jin Kim
Soon-Moon Jung Jae-Joo Shim
Won-Seok Cho
Jae-Hoon Jang
Kun-Ho Kwak

Execution Date(s) July 15, 2005

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: Samsung Electronics Co., Ltd

Internal Address: _____

Street Address: 416, Maetan-dong,

Yeongtong-gu

City: Suwon-si, Gyeonggi-do

State: _____

Country: Republic of Korea

Zip: _____

Additional name(s) & address(es) attached? Yes No

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3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
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- Other _____

4. Application or patent number(s):

This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Steven M. Mills

Internal Address: _____

Street Address: Mills & Onello LLP

Eleven Beacon Street, 605

City: Boston

State: Massachusetts

Zip: 02108

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6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
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9. Signature:

Steven M. Mills

Signature

8/5/05

Date

Steven M. Mills, Registration No. 36,610

Total number of pages including cover sheet, attachments, and documents:

4

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ASSIGNMENT

We, Jong-Hyuk Kim, of Na-102, Seungri Jutak, Bugae 1-dong, 301-1, B Byeong-gu, Incheon-si, Republic of Korea; Soon-Moon Jung, of 512-1401, Samsung 5-cha Apt., Bojeong-ri, Guseong-eup, Yongin-si, Gyeonggi-do, Republic of Korea; Won-Seok Cho, of 246-702, Hwanggol Maeul Ssangyong Apt., Yeongtong-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea; Jae-Hoon Jang, of 103, Cheonggye-ri, Dongtan-myeon, Hwaseong-si, Gyeonggi-do, Republic of Korea; Kun-Ho Kwak, of 207, Jinsung wonroom, Seocheon-ri, 322-8, Giheung-eup, Yongin-si, Gyeonggi-do, Republic of Korea; Sung-Jin Kim, of B-303, Banwol-ri, 100-22, Taean-eup, Hwaseong-si, Gyeonggi-do, Republic of Korea; and Jae-Joo Shim, of 203, Gisan 8-ri, Ildong-myeon, Pocheon-si, Gyeonggi-do, Gyeonggi-do, Republic of Korea, having invented improvements in METHOD OF FORMING SINGLE CRYSTAL SEMICONDUCTOR THIN FILM ON INSULATOR AND SEMICONDUCTOR DEVICE FABRIACTED THEREBY described in an application for Letters Patent of the United States, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignee our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and all countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.

First or Sole Inventor:

Signature: Jonghyuk Kim
Jong-Hyuk KimDate: 2005. 7. 15

Second Joint Inventor:

Signature: Soon-Moon Jung
Soon-Moon JungDate: 2005. 7. 15

Third Joint Inventor:

Signature: Won Seok Cho
Won-Seok ChoDate: 2005. 7. 15

Fourth Joint Inventor:

Signature: Jae-Hoon Jang
Jae-Hoon JangDate: 2005. 7. 15

Fifth Joint Inventor:

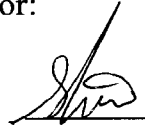
Signature: Kun-Ho Kwak
Kun-Ho KwakDate: 2005. 7. 15

Sixth Joint Inventor:

Signature: Sung Jin Kim
Sung-Jin KimDate: 2005. 7. 15

Seventh Joint Inventor:

Signature:


Jae-Joo Shim

Date: 2005, 1. 15

REFERENCE NO.: SAM-0759
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